

Title (en)

BIOSENSOR CHIP/DISPENSER ARRANGEMENT AND METHOD FOR DISPENSING A SOLUTION TO BE DISPENSED USING SAID DISPENSER DEVICE ON A BIOSENSOR CHIP

Title (de)

BIOSENSORCHIP-DISPENSIER-ANORDNUNG UND VERFAHREN ZUM DISPENSIEREN EINER ZU DISPENSIERENDEN LÖSUNG UNTER VERWENDUNG DER DISPENSIER-ANORDNUNG AUF EINEM BIOSENSORCHIP

Title (fr)

SYSTEME DE DISTRIBUTION SUR PUCE BIOCAPTEUR ET PROCEDE POUR LA DISTRIBUTION D'UNE SOLUTION A DISTRIBUER PAR UTILISATION DE CE SYSTEME DE DISTRIBUTION SUR UNE PUCE BIOCAPTEUR

Publication

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Application

**EP 02740301 A 20020429**

Priority

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Abstract (en)

[origin: WO02094442A1] The dispenser arrangement comprises a substrate (100). The substrate (100) has an upper and lower surface. The dispenser arrangement also comprises a dispenser device (103) for receiving a solution to be dispensed (104). The dispenser device (103) is arranged at a distance above the upper surface of the substrate (100) in such a way that the solution to be dispensed (104) can be dispensed above a given area (101) of the upper surface of the substrate (100). The substrate is electrically contacted in such a way that an electric potential can be generated between the given area and the dispenser device. The electric potential generated between the given area and the dispenser device makes it possible to control the direction in which the solution is dispensed towards said given area.

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IPC 8 full level

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